

1 pC Charge Injection, 100 pA Leakage CMOS ± 5 V/5 V/3 V 4-Channel Multiplexer

ADG604

FEATURES

1 pC Charge Injection (Over the Full Signal Range) ± 2.7 V to ± 5.5 V Dual Supply 2.7 V to 5.5 V Single Supply Automotive Temperature Range: -40° C to $+125^{\circ}$ C 100 pA Max @ 25°C Leakage Currents 85 Ω Typ On Resistance Rail-to-Rail Operation Fast Switching Times Typical Power Consumption (<0.1 μ W) TTL/CMOS Compatible Inputs 14-Lead TSSOP Package

APPLICATIONS

Automatic Test Equipment
Data Acquisition Systems
Battery-Powered Instruments
Communication Systems
Sample and Hold Systems
Remote-Powered Equipment
Audio and Video Signal Routing
Relay Replacement
Avionics

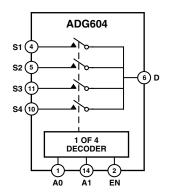
GENERAL DESCRIPTION

The ADG604 is a CMOS analog multiplexer, comprising four single channels. It operates from a dual supply of ± 2.7 V to ± 5.5 V, or from a single supply of 2.7 V to 5.5 V.

The ADG604 switches one of four inputs to a common output, D, as determined by the 3-bit binary address lines, A0, A1, and EN. A Logic "0" on the EN pin disables the device.

The ADG604 offers ultralow charge injection of ± 1.5 pC over the entire signal range and leakage currents of 10 pA typical at 25°C. It offers on resistance of 85 Ω typ, which is matched to within 2 Ω between channels. The ADG604 also has low power dissipation yet gives high switching speeds. The ADG604 is available in a 14-lead TSSOP package.

FUNCTIONAL BLOCK DIAGRAM



PRODUCT HIGHLIGHTS

- 1. Ultralow Charge Injection (Q $_{INJ}$: ± 1.5 pC Typ over the Full Signal Range)
- 2. Leakage Current <0.5 nA max @ 85°C
- 3. Dual ± 2.7 V to ± 5.5 V or Single 2.7 V to 5.5 V Supply
- 4. Fully Specified to 125°C
- 5. Small 14-Lead TSSOP Package

ADG604—SPECIFICATIONS

 $\textbf{DUAL SUPPLY}^{1} \quad (\textbf{V}_{DD} = +5 \ \textbf{V} \ \pm \ 10\%, \ \textbf{V}_{SS} = -5 \ \textbf{V} \ \pm \ 10\%, \ \textbf{GND} = 0 \ \textbf{V}. \ \textbf{All specifications} \ -40^{\circ} \textbf{C} \ to \ +125^{\circ} \textbf{C} \ unless \ otherwise \ noted.)$

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			V_{SS} to V_{DD}	V	
					$V_{DD} = +4.5 \text{ V}, V_{SS} = -4.5 \text{ V}$
On Resistance (R _{ON})	85			ΩTyp	$V_S = \pm 3 \text{ V}, I_S = -1 \text{ mA},$
0 D 1	115	140	160	Ω Max	Test Circuit 1
On Resistance Match Between	2			O Trm	$V_S = \pm 3 \text{ V}, I_S = -1 \text{ mA}$
Channels (ΔR_{ON})	2 4	5.5	6.5	Ω Typ Ω Max	$V_S - \pm 3 V$, $I_S1 \text{ mA}$
On-Resistance Flatness (R _{FLAT(ON)})	25	5.5	0.5	Ω Typ	$V_S = \pm 3 \text{ V}, I_S = -1 \text{ mA}$
On These transfer (T-FLAT(ON))	40	55	60	Ω Max	13 = 3 1, 25 - 2 222
LEAKAGE CURRENTS					V _{DD} = +5.5 V, V _{SS} = -5.5 V
Source OFF Leakage I _S (OFF)	±0.01			nA Typ	$V_{DD} = +3.5 \text{ V}, V_{SS} = -3.5 \text{ V}$ $V_{S} = \pm 4.5 \text{ V}, V_{D} = \mp 4.5 \text{ V},$
Source of 1 Leaning 13 (011)	±0.1	± 0.25	± 4	nA Max	Test Circuit 2
Drain OFF Leakage I _D (OFF)	±0.01			nA Typ	$V_S = \pm 4.5 \text{ V}, V_D = \mp 4.5 \text{ V},$
C 2 · ,	±0.1	± 0.5	±8	nA Max	Test Circuit 2
Channel ON Leakage $I_{D_s} I_S(ON)$	±0.01			nA Typ	$V_S = V_D = \pm 4.5 \text{ V}$, Test Circuit 3
	±0.1	± 0.5	± 10	nA Max	
DIGITAL INPUTS					
Input High Voltage, V _{INH}			2.4	V Min	
Input Low Voltage, V _{INL}			0.8	V Max	
Input Current					
I _{INL} or I _{INH}	0.005			μА Тур	$V_{IN} = V_{INL}$ or V_{INH}
			± 0.1	μΑ Max	
C _{IN} , Digital Input Capacitance	2			pF Typ	
DYNAMIC CHARACTERISTICS ²					
Transition Time	70			ns Typ	$V_{S1} = +3 \text{ V}, V_{S4} = -3 \text{ V}, R_L = 300 \Omega,$
P. 11	100	120	150	ns Max	$C_L = 35 \text{ pF}, \text{ Test Circuit 4}$
t _{ON} Enable	80	120	150	ns Typ	$R_L = 300 \Omega$, $C_L = 35 pF$
t _{OFF} Enable	105 30	130	150	ns Max ns Typ	$V_S = 3 \text{ V}$, Test Circuit 6 $R_L = 300 \Omega$, $C_L = 35 \text{ pF}$
toff Enable	45	55	65	ns Typ	$V_S = 3 \text{ V}$, Test Circuit 6
Break-Before-Make Time Delay, t _{BBM}	20	<i>JJ</i>	05	ns Typ	$R_L = 300 \Omega$, $C_L = 35 pF$,
Break Before Wake Time Belay, t _{BBM}	20		10	ns Min	$V_{S1} = V_{S2} = 3 \text{ V}, \text{ Test Circuit 5}$
Charge Injection	-1			рС Тур	$V_S = 0 \text{ V}, R_S = 0 \Omega, C_L = 1 \text{nF}, \text{ Test Circuit } 7$
Off Isolation	-75			dB Typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$,
					Test Circuit 8
Channel-to-Channel Crosstalk	-70			dB Typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$, Test Circuit 10
Bandwidth -3 dB	280			MHz Typ	$R_L = 50 \Omega$, $C_L = 5 pF$, Test Circuit 9
C _S (OFF)	5			pF Typ	f = 1 MHz
C_D (OFF)	17			pF Typ	f = 1 MHz
$C_D, C_S (ON)$	18			pF Typ	f = 1 MHz
POWER REQUIREMENTS					$V_{DD} = +5.5 \text{ V}, V_{SS} = -5.5 \text{ V}$
I _{DD}	0.001			μА Тур	Digital Inputs = 0 V or 5.5 V
			1.0	μΑ Max	_ ^
Iss	0.001			μА Тур	Digital Inputs = 0 V or 5.5 V
			1.0	μA Max	

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NOTES

1Y Version Temperature Range: -40°C to +125°C

²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

 $\textbf{SINGLE SUPPLY}^{1} \ \, (\textit{V}_{DD} = 5 \ \textit{V} \ \pm \ 10\%, \textit{V}_{SS} = 0 \ \textit{V}, \ \textit{GND} = 0 \ \textit{V}. \ \textit{All specifications} \ -40^{\circ}\textrm{C} \ to \ +125^{\circ}\textrm{C} \ unless \ otherwise \ noted.)$

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			$0~\mathrm{V}$ to V_{DD}	V	
					$V_{DD} = 4.5 \text{ V}, V_{SS} = 0 \text{ V}$
On Resistance (R _{ON})	210			ΩTyp	$V_S = 3.5 \text{ V}, I_S = -1 \text{ mA},$
	290	350	380	Ω Max	Test Circuit 1
On Resistance Match Between	_				
Channels (ΔR_{ON})	3			ΩТур	$V_S = 3.5 \text{ V}, I_S = -1 \text{ mA}$
		12	13	Ω Max	
LEAKAGE CURRENTS					$V_{\mathrm{DD}} = 5.5 \mathrm{V}$
Source OFF Leakage I _S (OFF)	±0.01			nA Typ	$V_S = 1 \text{ V}/4.5 \text{ V}, V_D = 4.5 \text{ V}/1 \text{ V},$
	±0.1	± 0.25	± 4	nA Max	Test Circuit 2
Drain OFF Leakage I _D (OFF)	±0.01			nA Typ	$V_S = 1 \text{ V}/4.5 \text{ V}, V_D = 4.5 \text{ V}/1 \text{ V},$
	±0.1	± 0.5	±8	nA Max	Test Circuit 2
Channel ON Leakage I_D , I_S (ON)	±0.01			nA Typ	$V_S = V_D = 4.5 \text{ V/1 V},$
	±0.1	±0.5	10	nA Max	Test Circuit 3
DIGITAL INPUTS					
Input High Voltage, V _{INH}			2.4	V Min	
Input Low Voltage, V _{INL}			0.8	V Max	
Input Current					
I _{INL} or I _{INH}	0.005			μА Тур	$V_{IN} = V_{INL}$ or V_{INH}
			± 0.1	μΑ Max	
C _{IN} , Digital Input Capacitance	2			pF Typ	
DYNAMIC CHARACTERISTICS ²					
Transition Time	90			ns Typ	$V_{S1} = 3 \text{ V}, V_{S4} = 0 \text{ V}, R_{L} = 300 \Omega,$
	-150	- 185 -	—210 - —	ns-Max-	C _L = 35 pF, Test Circuit 4
t _{ON} Enable	105			ns Typ	$R_L = 300 \Omega, C_L = 35 pF$
	150	190	220	ns Max	$V_S = 3 V$, Test Circuit 6
t _{OFF} Enable	45			ns Typ	$R_L = 300 \Omega, C_L = 35 pF$
	70	80	90	ns Max	$V_S = 3 V$, Test Circuit 6
Break-Before-Make Time Delay, t _{BBM}	30			ns Typ	$R_L = 300 \Omega$, $C_L = 35 pF$,
			10	ns Min	$V_{S1} = V_{S2} = 3 \text{ V, Test Circuit 5}$
Charge Injection	0.3			рС Тур	$V_S = 0 V$, $R_S = 0 \Omega$, $C_L = 1 nF$,
0001 1 :				ID T	Test Circuit 7
Off Isolation	-65			dB Typ	$R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz,$
	7.0			ID T	Test Circuit 8
Channel-to-Channel Crosstalk	-70			dB Typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$,
Bandwidth –3 dB	250			MHz Typ	Test Circuit 10 $R_L = 50 \Omega$, $C_L = 5 pF$, Test Circuit 9
C _S (OFF)	5			pF Typ	$K_L = 30 \Omega$, $C_L = 3 \text{ pr}$, rest Circuit 9 f = 1 MHz
$C_{S}(OFF)$ $C_{D}(OFF)$	17			pF Typ pF Typ	f = 1 MHz f = 1 MHz
C_D , C_S (ON)	18			pF Typ	f = 1 MHz f = 1 MHz
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POWER REQUIREMENTS					$V_{DD} = 5.5 \text{ V}$
T	0.001			4 T	Digital Inputs = 0 V or 5.5 V
I_{DD}	0.001		1.0	μΑ Тур	
			1.0	μA Max	

Specifications subject to change without notice.

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¹Y Version Temperature Range: -40°C to +125°C ²Guaranteed by design, not subject to production test.

ADG604—SPECIFICATIONS

Parameter	25°C	-40°C to +85°C	-40°C to +125°C	Unit	Test Conditions/Comments
ANALOG SWITCH					
Analog Signal Range			0 V to V_{DD}	V	
On Resistance (R _{ON})	380	420	460	ΩТур	$V_{\rm DD} = 2.7 \text{ V}, V_{\rm SS} = 0 \text{ V}$ $V_{\rm S} = 1.5 \text{ V}, I_{\rm S} = -1 \text{ mA},$ Test Circuit 1
On Resistance Match Between Channels (ΔR_{ON})			5	ΩТур	$V_S = 1.5 \text{ V}, I_S = -1 \text{ mA}$
LEAKAGE CURRENTS					$V_{DD} = 3.3 \text{ V}$
Source OFF Leakage I _S (OFF)	±0.01			nA Typ	$V_S = 1 \text{ V/3 V}, V_D = 3 \text{ V/1 V},$
	±0.1	± 0.25	± 4	nA Max	Test Circuit 2
Drain OFF Leakage I _D (OFF)	±0.01			nA Typ	$V_S = 1 \text{ V/3 V}, V_D = 3 \text{ V/1 V},$
	±0.1	± 0.5	±8	nA Max	Test Circuit 2
Channel ON Leakage I_D , I_S (ON)	±0.01			nA Typ	$V_S = V_D = 1 \text{ V/3 V},$
	±0.1	±0.5	±10	nA Max	Test Circuit 3
DIGITAL INPUTS					
Input High Voltage, V _{INH}			2.0	V Min	
Input Low Voltage, V _{INI}			0.8	V Max	
Input Current					
I _{INL} or I _{INH}	0.005			μА Тур	$V_{IN} = V_{INL}$ or V_{INH}
			± 0.1	μA Max	
C _{IN} , Digital Input Capacitance	2			pF Typ	
DYNAMIC CHARACTERISTICS ²					
Transition Time	170			ns Typ	$V_{S1} = 2 \text{ V}, V_{S4} = 0 \text{ V}, R_{L} = 300 \Omega,$
	320	390	450	ns Max	$C_L = 35 \text{ pF}, \text{ Test Circuit 4}$
t _{ON} Enable	180			ns Typ	$R_{L} = 300 \Omega, C_{L} = 35 \mathrm{pF}$
	- 250	265	-390	ns Max	$V_{\bar{S}} = 2 \text{-V}$, Test Circuit 6
t _{OFF} Enable	100			ns Typ	$R_L = 300 \Omega, C_L = 35 pF$
	160	205	225	ns Max	$V_S = 2 V$, Test Circuit 6
Break-Before-Make Time Delay, t _{BBM}	100			ns Typ	$R_L = 300 \Omega, C_L = 35 pF,$
			10	ns Min	$V_{S1} = V_{S2} = 2 \text{ V}$, Test Circuit 5
Charge Injection	0.3			pC Typ	$V_S = 0 \text{ V to } 3.3 \text{ V}, R_S = 0 \Omega, C_L = 1 \mu\text{F},$
					Test Circuit 7
Off Isolation	-65			dB Typ	$R_L = 50 \Omega$, $C_L = 5 pF$, $f = 10 MHz$,
					Test Circuit 8
Channel-to-Channel Crosstalk	70			dB Typ	$R_L = 50 \Omega, C_L = 5 pF, f = 10 MHz,$
D 1:11 0 ID	250			NIII T	Test Circuit 10
Bandwidth –3 dB	250			MHz Typ	$R_L = 50 \Omega$, $C_L = 5 pF$, Test Circuit 9
C_{S} (OFF)	5 17			pF Typ	f = 1 MHz f = 1 MHz
C_D (OFF) C_D , C_S (ON)	18			pF Typ pF Typ	f = 1 MHz f = 1 MHz
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POWER REQUIREMENTS					$V_{\rm DD} = 3.3 \text{ V}$
_					Digital Inputs = 0 V or 3.3 V
${ m I}_{ m DD}$	0.001		1.0	μА Тур	
			1.0	μA Max	

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NOTES 1 Y Version Temperature Range: -40° C to $+125^{\circ}$ C

²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

Junction Temperature
TSSOP Package
θ_{IA} Thermal Impedance
θ _{IC} Thermal Impedance
Lead Temperature, Soldering (10 seconds) 300°C
IR Reflow, Peak Temperature 220°C

NOTES

¹Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

²Overvoltages at EN, A0, A1, S, or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

ORDERING GUIDE

Model Option	Temperature Range	Package Description	Package
ADG604YRU	−40°C to +125°C	Thin Shrink Small Outline (TSSOP)	RU-14

PIN CONFIGURATION

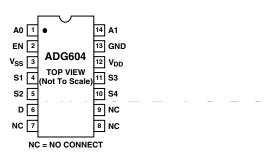


Table I. Truth Table

A1	A0	EN	ON Switch
X	X	0	None
0	0	1	1
0	1	1	2
1	0	1	3
_1	_1	1	4

CAUTION_

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG604 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high-energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



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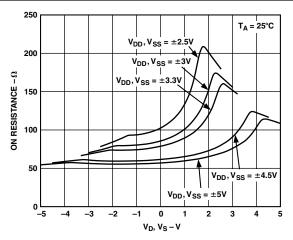
ADG604

TERMINOLOGY

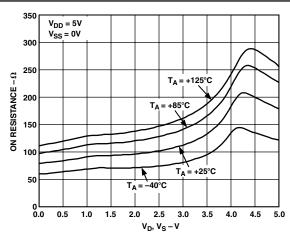
	TERMINOLOGY				
$\overline{V_{ m DD}}$	Most Positive Power Supply Potential				
V_{SS}	Most Negative Power Supply in a Dual Supply Application. In single supply applications, this should be tied to				
	ground at the device.				
GND	Ground (0 V) Reference				
I_{DD}	Positive Supply Current				
I_{SS}	Negative Supply Current				
S	Source Terminal. May be an input or output.				
D	Drain Terminal. May be an input or output.				
R_{ON}	Ohmic Resistance between D and S				
$\Delta R_{ m ON}$	On Resistance Match between any two channels, i.e., R_{ON} Max – R_{ON} Min				
$R_{FLAT(ON)}$	Flatness is defined as the difference between the maximum and minimum value of On resistance as measured				
	over the specified analog signal range.				
I_{S} (OFF)	Source Leakage Current with the Switch "OFF"				
I_D (OFF)	Drain Leakage Current with the Switch "OFF"				
$I_D, I_S (ON)$	Channel Leakage Current with the Switch "ON"				
V_D, V_S	Analog Voltage on Terminals D, S				
V_{INL}	Maximum Input Voltage for Logic "0"				
V_{INH}	Minimum Input Voltage for Logic "1"				
$I_{INL}(I_{INH})$	Input Current of the Digital Input				
C _S (OFF)	Channel Input Capacitance for "OFF" Condition				
C_D (OFF)	Channel Output Capacitance for "OFF" Condition				
$C_D, C_S (ON)$	"On" Switch Capacitance				
C_{IN}	Digital Input Capacitance				
t_{ON} (EN)	Delay time between the 50% and 90% points of the digital input and switch "ON" condition.				
t_{OFF} (EN)	Delay time between the 50% and 90% points of the digital input and switch "OFF" condition.				
t _{TRANSITION}	Delay time between the 50% and 90% points of the digital input and switch "ON" condition when switching				
	from one address state to another.				
t_{BBM}	"OFF" time or "ON" time measured between the 80% points of both switches, when switching from one address				
	state to another.				
Charge Injection	A measure of the glitch impulse transferred from the digital input to the analog output during switching.				
Crosstalk	A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.				
Off Isolation	A measure of unwanted signal coupling through an "On" switch.				
Bandwidth	Frequency Response of the "On" Switch				
Insertion Loss	Loss Due to the On Resistance of the Switch				

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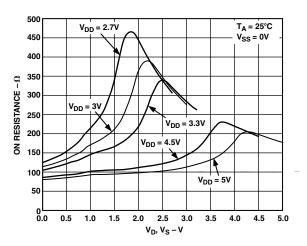
Typical Performance Characteristics—ADG604



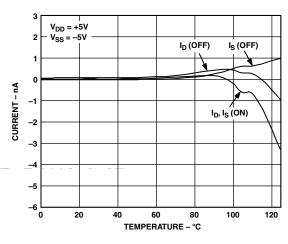
TPC 1. On Resistance vs. V_D (V_S), Dual Supply



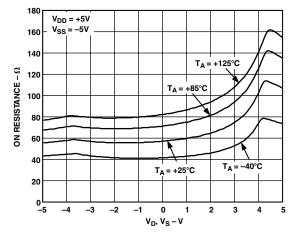
TPC 4. On Resistance vs. V_D (V_S) for Different Temperatures, Single Supply



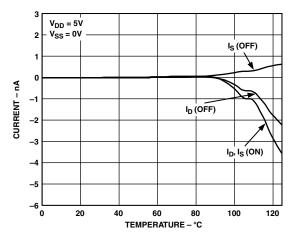
TPC 2. On Resistance vs. V_D (V_S), Single Supply



TPC 5. Leakage Currents vs. Temperature, Dual Supply



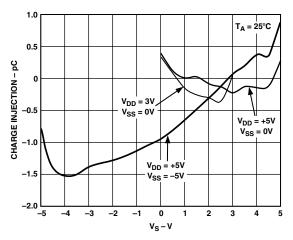
TPC 3. On Resistance vs. V_D (V_S) for Different Temperatures, Dual Supply



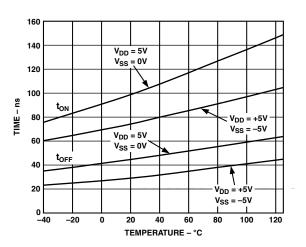
TPC 6. Leakage Currents vs. Temperature, Single Supply

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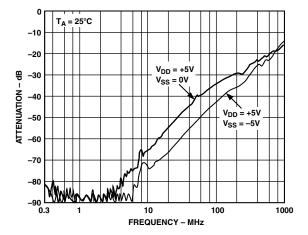
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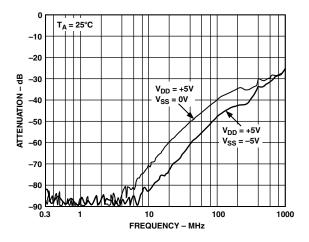
TPC 7. Charge Injection vs. Source Voltage



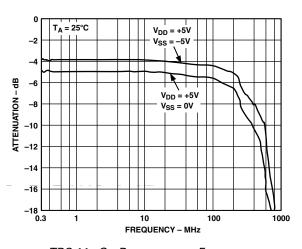
TPC 8. t_{ON}/t_{OFF} Times vs. Temperature



TPC 9. Off Isolation vs. Frequency



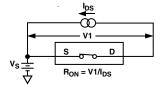
TPC 10. Crosstalk vs. Frequency



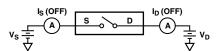
TPC 11. On Response vs. Frequency

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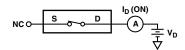
Test Circuits



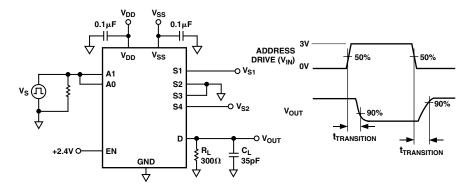
Test Circuit 1. On Resistance



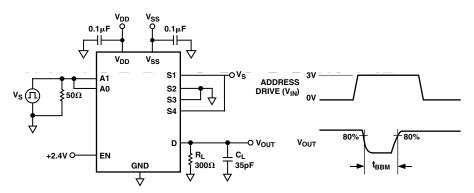
Test Circuit 2. Off Leakage



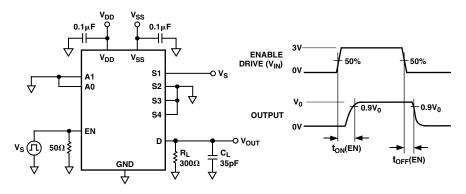
Test Circuit 3. On Leakage



Test Circuit 4. Switching Time of Multiplexer, t_{TRANSITION}



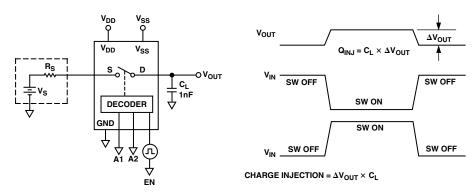
Test Circuit 5. Break-Before-Make Delay, t_{BBM}



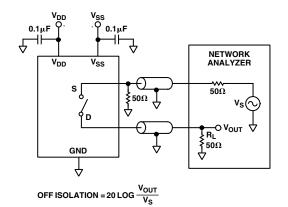
Test Circuit 6. Enable Delay, t_{ON} (EN), t_{OFF} (EN)

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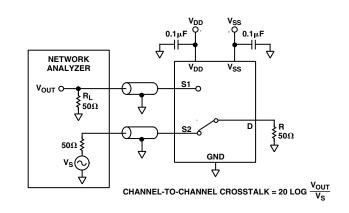
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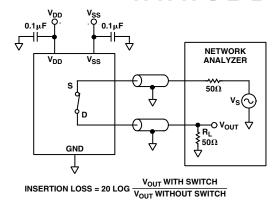
Test Circuit 7. Charge Injection



Test Circuit 8. Off Isolation



Test Circuit 10. Channel-to-Channel Crosstalk

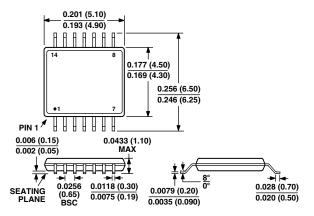


Test Circuit 9. Bandwidth

OUTLINE DIMENSIONS

Dimensions shown in inches and (mm).

14-Lead TSSOP Package (RU-14)



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-12-